TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

T C 7 M H 1 5 3 F K

Dual 4-Channel Multiplexer

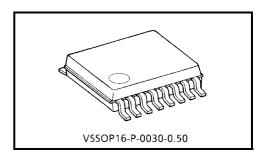
The TC7MH153FK is an advanced high speed CMOS dual 4-channel multiplexers fabricated with silicon gate ${\rm C^2MOS}$ technology.

It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

Each of these data (1C0-1C3, 2C0-2C3) is selected by the two address inputs A and B.

Separate strobe inputs ($1\overline{G}$, $\ 2\overline{G}$) are provided for each of the two four-line sections.

The strobe input (\overline{G}) can be used to inhibit the data output; the output is fixed in low level while the strobe input is held high.



Weight: 0.02 g (typ.)

An input protection circuit ensures that 0 to 7 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High speed: $t_{pd} = 5.0 \text{ ns (typ.) (VCC} = 5 \text{ V)}$
- Low power dissipation: $ICC = 4 \mu A \text{ (max)} \text{ (Ta} = 25 \text{°C)}$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_pLH \approx t_pHL$
- Wide operating voltage range: VCC (opr) = 2~5.5 V
- Pin and function compatible with 74ALS153

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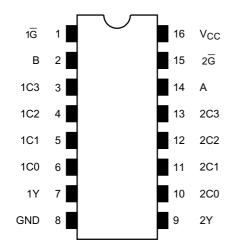
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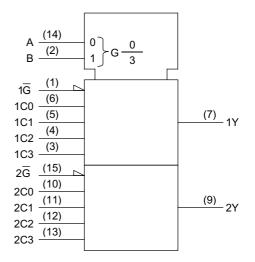
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Pin Assignment (top view)



IEC Logic Symbol

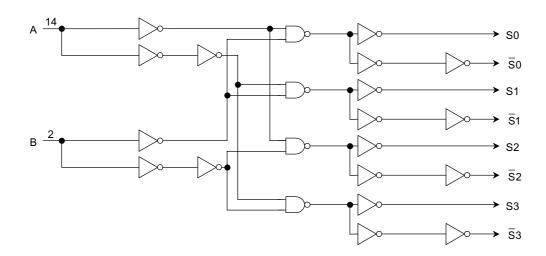


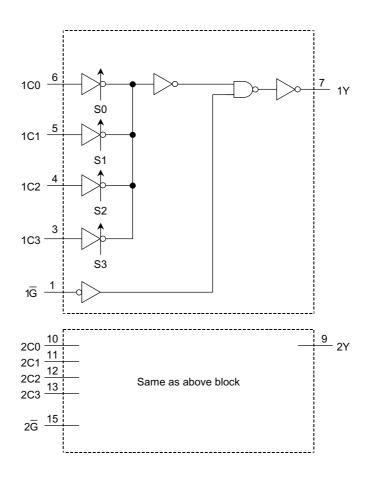
Truth Table

	Select Inputs		Data	Inputs		Strobe	Output	
В	Α	C0	C1	C2	C3	IG	Υ	
Х	Х	Х	Х	Х	Х	Н	L	
L	L	L	Х	Х	Х	L	L	
L	L	Н	Х	Х	Х	L	Н	
L	Н	Х	L	Х	Х	L	L	
L	Н	Х	Н	Х	Х	L	Н	
Н	L	Х	Х	L	Х	L	L	
Н	L	Х	Х	Н	Х	L	Н	
Н	Н	Х	Х	Х	L	L	L	
Н	Н	Х	Х	Х	Н	L	Н	

X: Don't care

System Diagram







Maximum Ratings

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7.0	V
DC input voltage	V _{IN}	-0.5~7.0	V
DC output voltage	V _{OUT}	-0.5~V _{CC} + 0.5	V
Input diode current	I _{IK}	-20	mA
Output diode current	I _{OK}	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T _{stg}	-65~150	°C

Recommended Operating Conditions

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	2.0~5.5	V	
Input voltage	V _{IN}	0~5.5	V	
Output voltage	V _{OUT}	0~V _{CC}	V	
Operating temperature	T _{opr}	-40~85	°C	
Input rise and fall time	dt/dv	$0\sim100 \ (V_{CC}=3.3\pm0.3 \ V)$	ns/V	
input rise and rail time	αί/αν	$0\sim20 \ (V_{CC}=5\pm0.5 \ V)$	115/ V	

Electrical Characteristics

DC Characteristics

Characteristics		Symbol	Test Condition				Ta = 25°C		Ta = -40~85°C		Unit
		Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
					2.0	1.50	_	_	1.50	_	
	High level	V _{IH}			3.0~5.5	$\begin{matrix} V_{CC} \\ \times 0.7 \end{matrix}$	_	_	V _{CC} ×0.7	_	V
Input voltage		V _{IL}	_		2.0	_	_	0.50	_	0.50	
	Low level				3.0~5.5	-	-	$\begin{array}{c} V_{CC} \\ \times 0.3 \end{array}$	_	V _{CC} ×0.3	
	High level	Vон	V _{IN} = V _{IH} or V _{IL}	Ι _{ΟΗ} = –50 μΑ	2.0	1.9	2.0	_	1.9	_	· V
					3.0	2.9	3.0	_	2.9	_	
					4.5	4.4	4.5	_	4.4	_	
Output voltage				$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48	_	
				$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_	
Output Voltage	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	Ι _{ΟL} = 50 μΑ	2.0	_	0	0.1	_	0.1	
					3.0	_	0	0.1	_	0.1	
					4.5		0	0.1	_	0.1	
				$I_{OL} = 4 \text{ mA}$	3.0	_	_	0.36	_	0.44	
				$I_{OL} = 8 \text{ mA}$	4.5			0.36	_	0.44	
Input leakage current		I _{IN}	V _{IN} = 5.5 V or GND		0~5.5	_		±0.1	_	±1.0	μΑ
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND		5.5			4.0		40.0	μΑ



AC Characteristics (Input: $t_r = t_f = 3 \text{ ns}$)

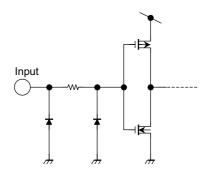
Characteristics	Symbol	Toot Condition			Ta = 25°C			Ta = -40~85°C		Unit
Characteristics		Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Offic
		_	3.3 ± 0.3	15	_	7.7	11.9	1.0	14.0	
Propagation delay time	t _{pLH} t _{pHL}		3.3 ± 0.3	50	_	10.2	15.4	1.0	17.5	ns ns
(C _n -Y)			5.0 ± 0.5	15		5.0	7.7	1.0	9.0	
			3.0 ± 0.5	50		6.5	9.7	1.0	11.0	
		_	3.3 ± 0.3	15		10.8	16.7	1.0	19.5	ns
Propagation delay time	t _{pLH} t _{pHL}			50		13.3	20.2	1.0	23.0	
(A, B-Y)			5.0 ± 0.5	15		6.8	9.9	1.0	11.5	
				50	_	8.3	11.9	1.0	13.5	
		_	3.3 ± 0.3	15	_	6.3	10.1	1.0	12.0	
Propagation delay time	t _{pLH}			50		8.8	13.6	1.0	15.5	
(G -Y)	t _{pLH} t _{pHL}		5.0 ± 0.5	15		4.4	6.4	1.0	7.5	
				50		5.9	8.4	1.0	9.5	
Input capacitance	C _{IN}	-	_		_	4	10	_	10	pF
Power dissipation capacitance	C _{PD}			(Note)	_	20	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

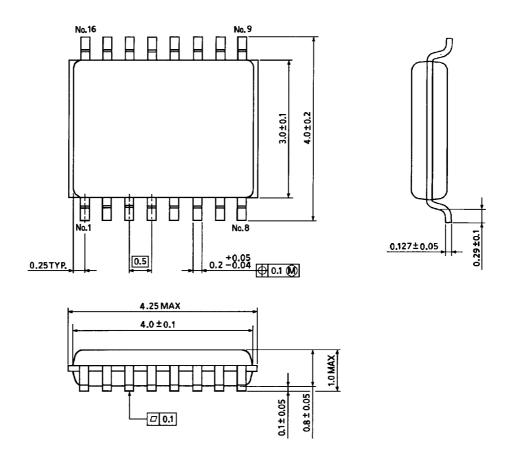
Average operating current can be obtained by the equation:

ICC (opr) = CPD · VCC · fIN + ICC

Input Equivalent Circuit



Package Dimensions



Weight: 0.02 g (typ.)